

# H5N2802PF

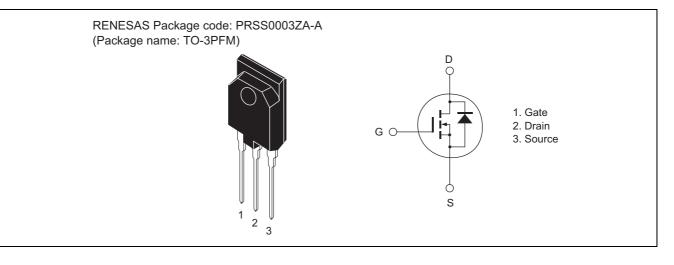
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1298-0100 Rev.1.00 Oct.05.2005

### **Features**

- Low on-resistance
- Low leakage current
- High speed switching

### Outline



## **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	280	V
Gate to source voltage	V <sub>GSS</sub>	±30	V
Drain current	I <sub>D</sub>	25	А
Drain peak current	Note1 I <sub>D (pulse)</sub>	100	А
Body-drain diode reverse drain current	I <sub>DR</sub>	25	А
Body-drain diode reverse drain peak current	Note1 DR (pulse)	100	А
Avalanche current	I <sub>AP</sub> <sup>Note3</sup>	13	А
Avalanche energy	E <sub>AR</sub> <sup>Note3</sup>	10.2	mJ
Channel dissipation	Pch Note2	60	W
Channel to case thermal impedance	θch-c	2.08	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	۵°

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

2. Value at  $Tc = 25^{\circ}C$ 

3. STch =  $25^{\circ}$ C, Tch  $\leq 150^{\circ}$ C



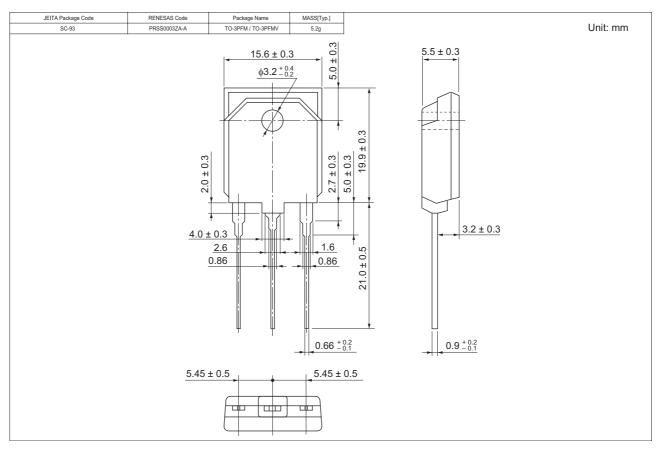
## **Electrical Characteristics**

Item	Symbol	Min	Тур	Max	Unit	Test conditions	
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	280	_	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$	
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 280 \text{ V}, V_{GS} = 0$	
Gate to source leak current	I <sub>GSS</sub>	_	—	±0.1	μΑ	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$	
Gate to source cutoff voltage	V <sub>GS(off)</sub>	3.0	—	4.0	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	
Forward transfer admittance	y <sub>fs</sub>	15	27	—	S	$I_D = 12.5 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$	
Static drain to source on state resistance	R <sub>DS(on)</sub>	_	0.057	0.066	Ω	$I_D = 12.5 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$	
Input capacitance	Ciss	_	3600	_	pF	$V_{DS} = 25 V, V_{GS} = 0,$ f = 1 MHz	
Output capacitance	Coss	_	450	—	pF		
Reverse transfer capacitance	Crss	_	32	_	pF		
Turn-on delay time	t <sub>d(on)</sub>	_	50	—	ns	$I_D$ = 12.5 A, V <sub>GS</sub> = 10 V, R <sub>L</sub> = 11.2 Ω, Rg = 10 Ω	
Rise time	tr	_	90	—	ns		
Turn-off delay time	t <sub>d(off)</sub>	—	120	—	ns		
Fall time	t <sub>f</sub>	—	75	—	ns		
Total gate charge	Qg	_	72	—	nC	$V_{DD} = 220 \text{ V}, \text{ V}_{GS} = 10 \text{ V},$ $I_D = 25 \text{ A}$	
Gate to source charge	Qgs	_	18	—	nC		
Gate to drain charge	Qgd	_	24	_	nC		
Body-drain diode forward voltage	V <sub>DF</sub>	_	0.88	1.40	V	$I_F = 25 \text{ A}, V_{GS} = 0^{Note4}$	
Body-drain diode reverse recovery time	t <sub>rr</sub>	_	200	_	ns	$I_F = 25 \text{ A}, V_{GS} = 0,$	
Body-drain diode reverse recovery charge	Qrr	_	1.4	—	μC	di <sub>F</sub> /dt = 100 A/µs	

Notes: 4. Pulse test



## **Package Dimensions**



## **Ordering Information**

Part Name	Quantity	Shipping Container
H5N2802PF-E	30 pcs	Plastic magazine

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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